	Material Composit © Copyright 2005. IPC, I nternational and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a decla he declaratio	aration o on encor	of the subs mpasses al	stances w 11 lower l	ithin the n evel mate	nanufacture rials for wh	er listed ite hich the ma	em. Note unufactu	e: if the i irer has e	item is an asse	mbly with lowe sponsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribu				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materia	als and Mfg Information					
Supplier Informati	on																
Company name*			Company unique ID				Unique ID Authority						Response Date*				
onsemi											2024-05-21						
Contact Name			Title - Contact				Phone - Contact*						Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA						Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*						Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA						Product-Env-Stewards@onsemi.com				
Requester Ite	Requester Item Number Mfr Iter		Number	Mfr Item Name			Effective D	Date V	Version	Ma	Manufacturing Site		V	veight*	1	UOM	Unit Type
	NC7SZ1		9L6X	UHS 1-of-2 Decoder/Demux			2024-05-21	1		Tŀ	ТНВ		2	09	1	mg	Each
Manufacturing Pro	occess Information	l								I							·
Terminal Plating / Grid Array Material		d To	erminal Base A	ninal Base Alloy J-ST		L Rating	Peak P	Peak Process Body Tempera		perature	ture Max Time at Peak T		Temperature Number		mber of Reflow Cycles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		l) (no C	CU Alloy 1		1		260		С		30		seconds 3				
Comments											·						
evel 1 - maximum time	at peak temperature d	uring sol	dering is 10-3	0 seconds													
For more information r	egarding material com	position <b>p</b>	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS RoHS Performance (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (DBP), Dibutyl phthalate (DB										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.04	mg	Supplier	Silicon (Si)	7440-21-3		0.04	mg
Die Attach Tape	0.003	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0005	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2- methyl-2-propenoate	25035-69-2		0.0005	mg
			Supplier	Proprietary	Proprietary Data		0.0003	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0013	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0005	mg
Lead Frame	0.803	mg	Supplier	Magnesium (Mg)	7439-95-4		0.001	mg
			Supplier	Silicon (Si)	7440-21-3		0.0063	mg
			В	Nickel (Ni)	7440-02-0		0.0261	mg
			Supplier	Copper (Cu)	7440-50-8		0.7696	mg
Mold Compound-Black	1.207	mg		Epoxy resin	proprietary data		0.0604	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0278	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0604	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0048	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0278	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.026	mg
Plating	0.025	mg	Supplier	Silver (Ag)	7440-22-4		0.0001	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0002	mg
			В	Nickel (Ni)	7440-02-0		0.0247	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
Wire Bond	0.012	mg	Supplier	Palladium (Pd)	7440-05-3		0.0002	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0117	mg